

FEATURES

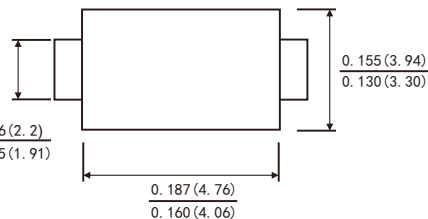
- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- Metal silicon junction ,majority carrier conduction
- Guard ring for overvoltage protection
- Low power loss ,high efficiency
- High current capability ,low forward voltage drop
- High surge capability
- High temperature soldering guaranteed:260°C/10 seconds at terminals
- Component in accordance to RoHS 2011/65/EU



RoHS
COMPLIANT

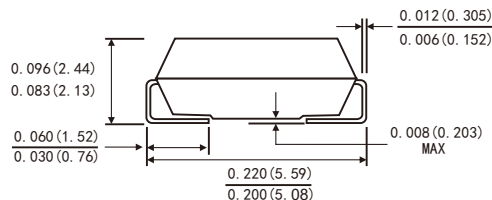
0.086 (2.2)
0.075 (1.91)

SMB(DO-214AA)

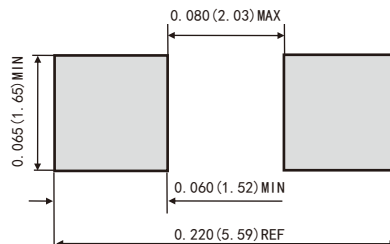


MECHANICAL DATA

- Case: JEDEC SMB(DO-214AA) molded plastic body
- Terminals: Solder Plated, solderable per MIL-STD-750,method 2026
- Polarity: Color band denotes cathode end
- Weight: 0.003ounce, 0.093 gram



Suggested PAD Layout



Dimensions in inches and (millimeters)

TYPICAL APPLICATIONS

For use in low voltage ,high frequency inverters ,DC/DC converters,
free wheeling ,and polarity protection applications

MAXIMUM RATINGS

(Ratings at 25°C ambient temperature unless otherwise specified)

Parameter	Symbol	Value	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	100	V
Maximum average forward rectified current (see fig.1)	$I_F(AV)$	5.0	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC method at rated TL)	I_{FSM}	150	A
Operating junction temperature range	T_J	-55 to +150	°C
Storage temperature range	T_{stg}	-55 to +150	°C

RATINGS AND CHARACTERISTIC OF SS510SLB

ELECTRICAL CHARACTERISTICS (T_A=25℃ Unless otherwise noted)

Parameter	Test Conditions		Symbol	TYP.	MAX.	Unit
Instaneous forward voltage	I _F =5.0A	T _A =25℃	V _F ¹⁾	0.55	0.58	V
		T _A =100℃		0.52	—	
		T _A =125℃		0.50	—	
Reverse current	V _R =100V	T _A =25℃	I _R ²⁾	20	50	μA
		T _A =100℃		2.0	5	mA
		T _A =125℃		8	20	
Typical junction capacitance	4V, 1MHz		C _J	370		pF

Notes: 1.Pulse test: 300 μs pulse width, 1% duty cycle
2.Pulse test: pulse width≤40ms

THERMAL CHARACTERISTICS

Parameter	Symbol	SMB	Unit
Typical thermal resistance ³⁾	R _{θJA}	70.0	℃/W
	R _{θJL}	15.0	

3. Unit mounted on PC board with 5.0mm×5.0 mm (0.013 mm thick) copper pads as heat sink

AVAILABLE PACK INFORMATION

Product code	Pack	Reel Size (mm)	Quantity (pcs/reel)	Box Size L×W×H (mm)	Quantity (reel/box)	Carton Size L×W×H (mm)	Quantity (box/carton)
SS510SLB-SMB	T/R	Φ300	3000	340×340×40	2	370×370×370	8

RATINGS AND CHARACTERISTIC OF SS510SLB

FIG.1-FORWARD CURRENT DERATING CURVE

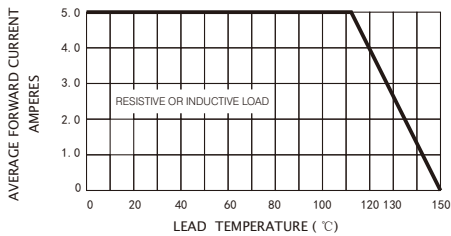


FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

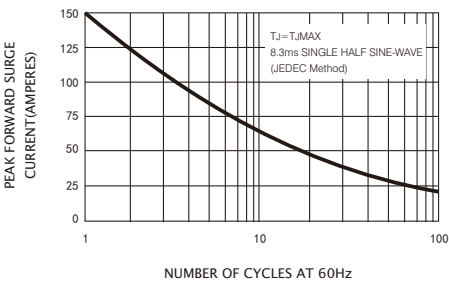


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

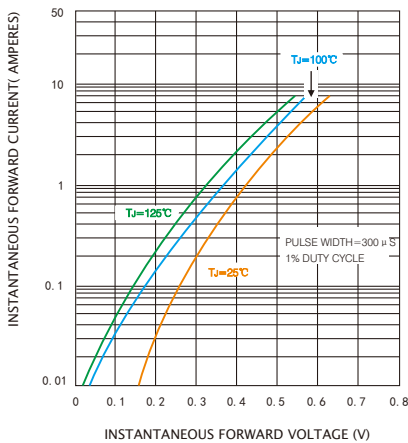


FIG.4-TYPICAL REVERSE CHARACTERISTICS

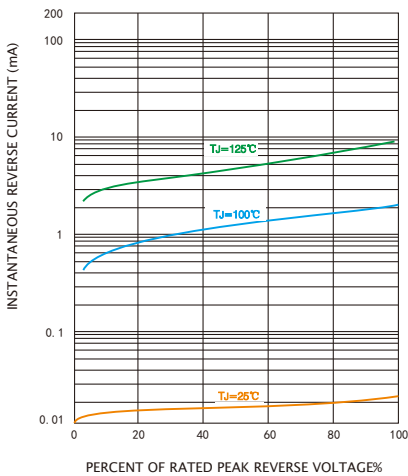


FIG.5-TYPICAL JUNCTION CAPACITANCE

